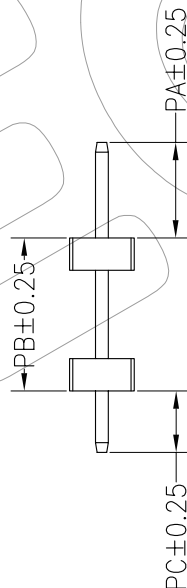
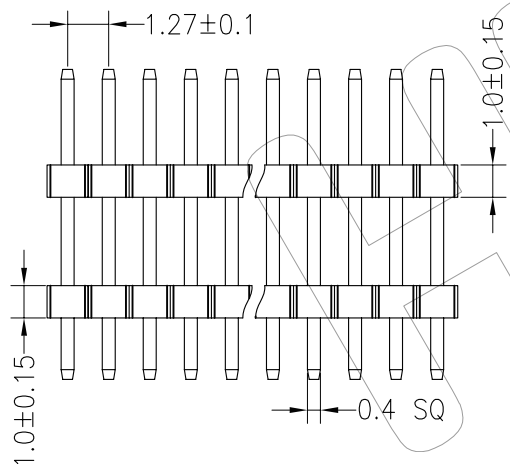
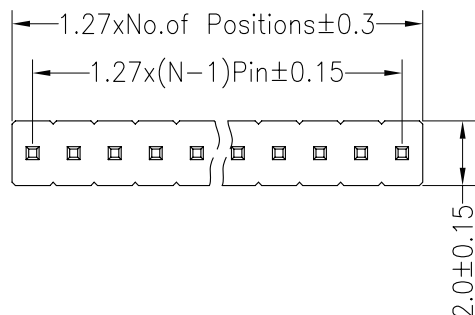
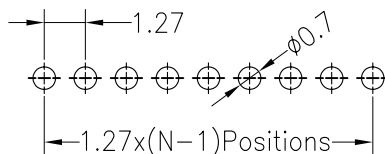


RoHS

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)



SPECIFICATIONS

Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:-40°C to +105°C
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)

Dimension antitheses list

ITEM	PA	PB	PC	L
Standard	1.80	2.00	1.80	5.60
Alternate				

Ordering Information

HC-PH710 21 XX X N XX S XXX X 01

No.of
Pins
Per Row
1*1~1*50

Insulator Material
Option
A=BK-PBT
B=BK-PA66
C=BK-PA6T
D=BK-PA46
E=BK-PA9T
F=BK-LCP

Contact Plating
G0:Gold Flash
G1:3U" Gold
G2:5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold
S0:Gold Flash/Tin
SN:Tin

Pin Length
Packing
O=PE Bag
A=Tray
T=Tube
P=Tube+Cap
R=Reel+Cap
M=Reel+Mylar

OPERATION

X.X ±0.30
X.XX ±0.20
X.XXX ±0.10
Angle ±3°
DIM TOL

DRAW

Lu jin ying

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

◆

HECON 东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC- PH710-21-XX-X-N-XX-S-XXX-X01

TITLE:

1.27PH 2+H1.0mm 1xNpin DIP